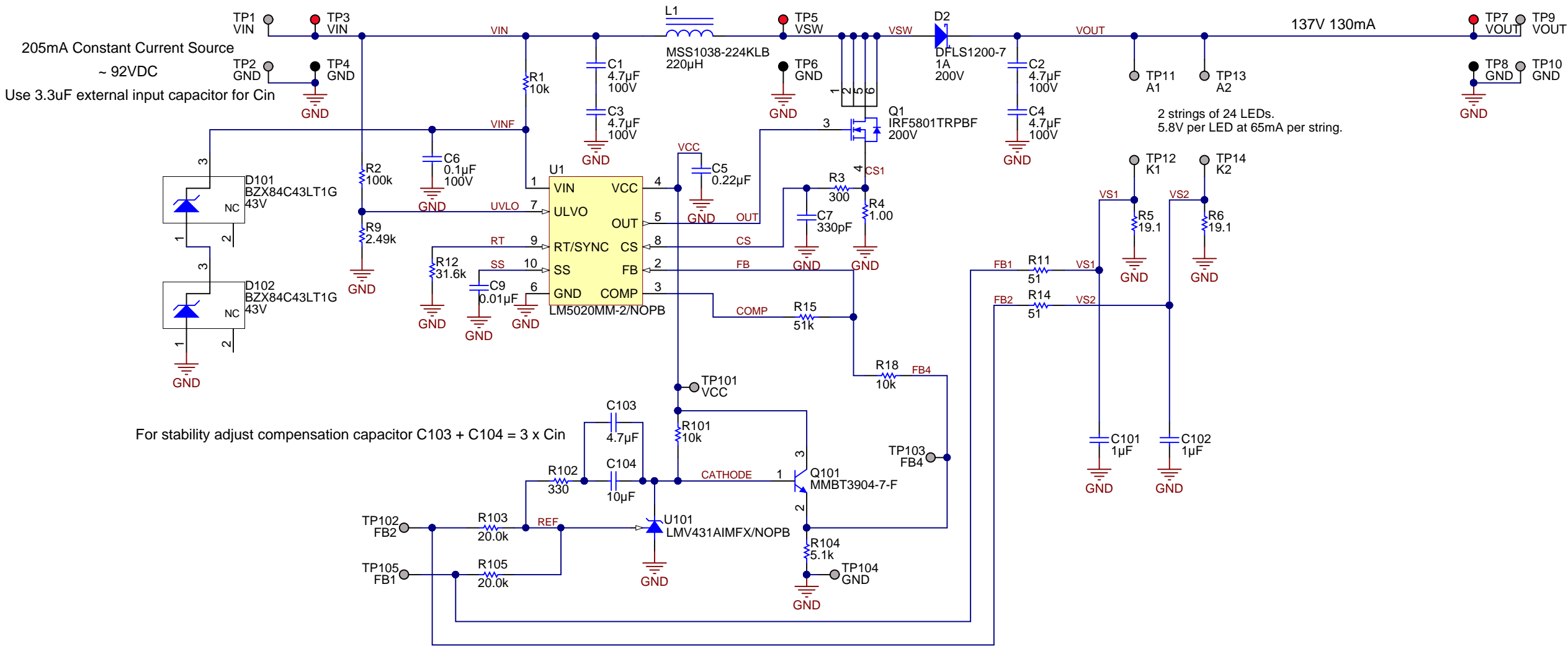


Notes:  
1. Built on PMP10505 Rev A printed circuit board.  
2. Reference designators greater than 100 are additional components that do not appear on the Rev A printed circuit board.  
3. For constant voltage load testing set load to 126V and use 200 ohms series resistance per string to model the LED forward voltage and dynamic resistance.  
4. For frequency response testing use 220uF 200V aluminum electrolytic capacitor across the constant voltage load.

Revision History	
Revision	Notes
A	Initial design





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